



NZX series

Single Zener diodes

Rev. 02 — 3 June 2009

Product data sheet

1. Product profile

1.1 General description

General-purpose Zener diodes in a SOD27 (SC-40) small hermetically sealed glass package.

1.2 Features

- Total power dissipation: $P_{\text{tot}} \leq 500 \text{ mW}$
- Low differential resistance
- Low leakage current
- AEC-Q101 qualified

1.3 Applications

- General regulation functions

1.4 Quick reference data

Table 1. Quick reference data
 $T_j = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 200 \text{ mA}$	[1] -	-	1.5	V

[1] Pulse test: $t_p \leq 300 \mu\text{s}$; $\delta \leq 0.02$.

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	
2	anode		

[1] The marking band indicates the cathode.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
NZX2V4A to NZX36X ^[1]	SC-40	hermetically sealed glass package; axial leaded; 2 leads	SOD27

[1] The series consists of 111 types with nominal working voltages from 2.4 V to 36 V.

4. Marking

Table 4. Marking codes

Type number	Marking code
NZX2V4A to NZX36X	the diodes are type branded

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
I_F	forward current		-	250	mA
P_{tot}	total power dissipation	$T_{tp} \leq 25\text{ °C}$	-	500	mW
T_j	junction temperature		-	175	°C
T_{amb}	ambient temperature		-55	+175	°C
T_{stg}	storage temperature		-65	+175	°C

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	^[1] -	-	380	K/W
$R_{th(j-t)}$	thermal resistance from junction to tie-point		^[1] -	-	300	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB) without metallization pad; maximum lead length 8 mm.

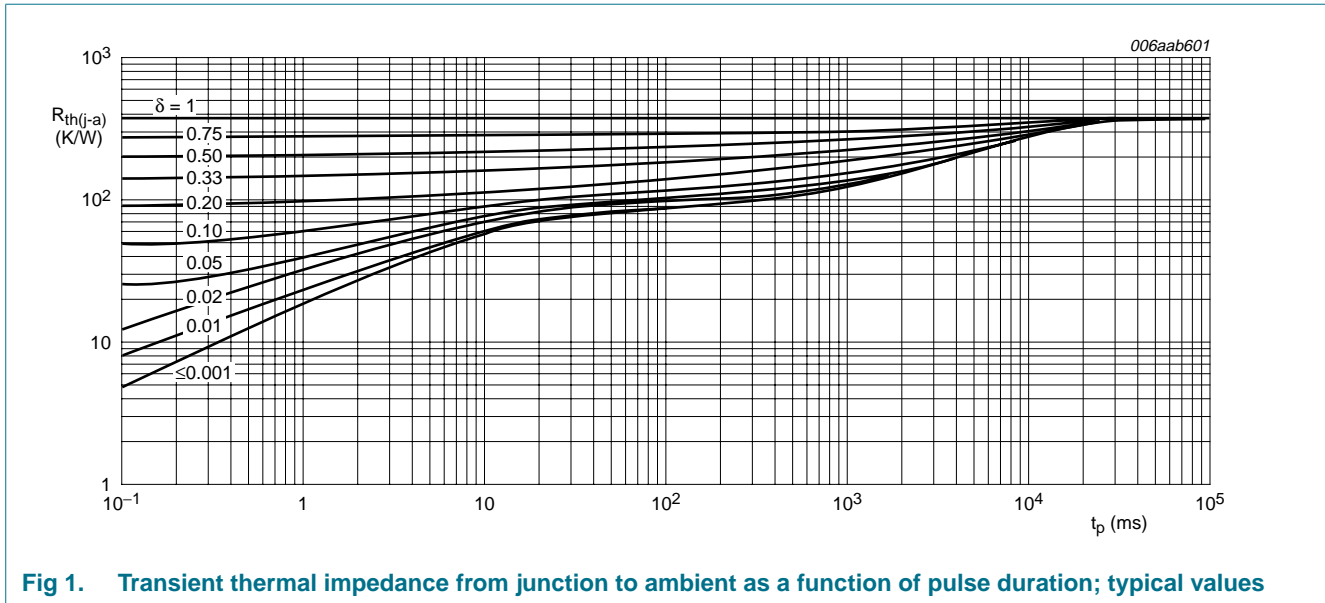


Fig 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

7. Characteristics

Table 7. Characteristics

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 200\text{ mA}$	[1]	-	1.5	V

[1] Pulse test: $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$.

Table 8. Characteristics per type; NZX2V4A to NZX18C

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

NZXxxx	Sel	Working voltage V_Z (V)		Differential resistance r_{dif} (Ω)	Reverse current I_R (μA)	
		$I_Z = 5\text{ mA}$		$I_Z = 5\text{ mA}$	Max	V_R (V)
		Min	Max	Max		
2V4	A	2.3	2.5	100	50	1
	B	2.4	2.6			
2V7	A	2.5	2.7	100	20	1
	B	2.6	2.8			
	C	2.7	2.9			
3V0	A	2.8	3.0	100	10	1
	B	2.9	3.1			
	C	3.0	3.2			
3V3	A	3.1	3.3	100	5	1
	B	3.2	3.4			
	C	3.3	3.5			

Table 8. Characteristics per type; NZX2V4A to NZX18C ...continued
 $T_j = 25^\circ\text{C}$ unless otherwise specified.

NZXxxx	Sel	Working voltage V_Z (V)		Differential resistance r_{dif} (Ω)	Reverse current I_R (μA)	
		$I_Z = 5\text{ mA}$		$I_Z = 5\text{ mA}$	Max	V_R (V)
		Min	Max	Max		
3V6	A	3.4	3.6	100	5	1
	B	3.5	3.7			
	C	3.6	3.8			
3V9	A	3.7	3.9	100	3	1
	B	3.8	4.0			
	C	3.9	4.1			
4V3	A	4.0	4.2	100	3	1
	B	4.1	4.3			
	C	4.2	4.4			
	D	4.3	4.5			
4V7	A	4.4	4.6	100	3	2
	B	4.5	4.7			
	C	4.6	4.8			
	D	4.7	4.9			
5V1	A	4.8	5.0	100	2	2
	B	4.9	5.1			
	C	5.0	5.2			
	D	5.1	5.3			
5V6	A	5.2	5.5	40	1	2
	B	5.3	5.6			
	C	5.4	5.7			
	D	5.5	5.8			
	E	5.6	5.9			
6V2	A	5.7	6.0	15	3	4
	B	5.8	6.1			
	C	6.0	6.3			
	D	6.1	6.4			
	E	6.3	6.6			
6V8	A	6.4	6.7	15	2	4
	B	6.6	6.9			
	C	6.7	7.0			
	D	6.9	7.2			

Table 8. Characteristics per type; NZX2V4A to NZX18C ...continued
 $T_j = 25^\circ\text{C}$ unless otherwise specified.

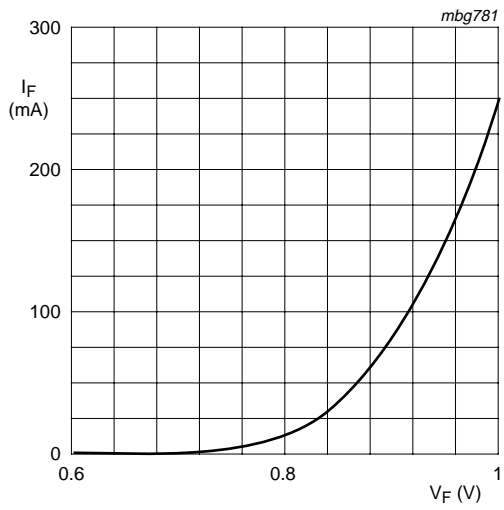
NZXxxx	Sel	Working voltage V_Z (V)		Differential resistance r_{dif} (Ω)	Reverse current I_R (μA)	
		$I_Z = 5\text{ mA}$		$I_Z = 5\text{ mA}$	Max	V_R (V)
		Min	Max	Max		
7V5	A	7.0	7.3	15	1	5
	B	7.2	7.6			
	C	7.3	7.7			
	D	7.5	7.9			
	X	7.07	7.45			
8V2	A	7.7	8.1	20	0.7	5
	B	7.9	8.3			
	C	8.1	8.5			
	D	8.3	8.7			
9V1	A	8.5	8.9	20	0.5	6
	B	8.7	9.1			
	C	8.9	9.3			
	D	9.1	9.5			
	E	9.3	9.7			
10	A	9.5	9.9	25	0.2	7
	B	9.7	10.1			
	C	9.9	10.3			
	D	10.2	10.6			
11	A	10.4	10.8	25	0.1	8
	B	10.7	11.1			
	C	10.9	11.3			
	D	11.1	11.6			
12	A	11.4	11.9	35	0.1	8
	B	11.6	12.1			
	C	11.9	12.4			
	D	12.2	12.7			
	X	11.44	12.03			
13	A	12.4	12.9	35	0.1	8
	B	12.6	13.1			
	C	12.9	13.4			
14	A	13.2	13.7	35	0.05	9.8
	B	13.5	14.0			
	C	13.8	14.3			

Table 8. Characteristics per type; NZX2V4A to NZX18C ...continued
T_j = 25 °C unless otherwise specified.

NZXxxx	Sel	Working voltage V _Z (V)		Differential resistance r _{dif} (Ω)	Reverse current I _R (μA)	
		I _Z = 5 mA		I _Z = 5 mA	Max	V _R (V)
		Min	Max	Max		
15	A	14.1	14.7	40	0.05	10.5
	B	14.5	15.1			
	C	14.9	15.5			
	X	14.35	15.09			
16	A	15.3	15.9	45	0.05	11.2
	B	15.7	16.5			
	C	16.3	17.1			
18	A	16.9	17.7	55	0.05	12.6
	B	17.5	18.3			
	C	18.1	19.0			

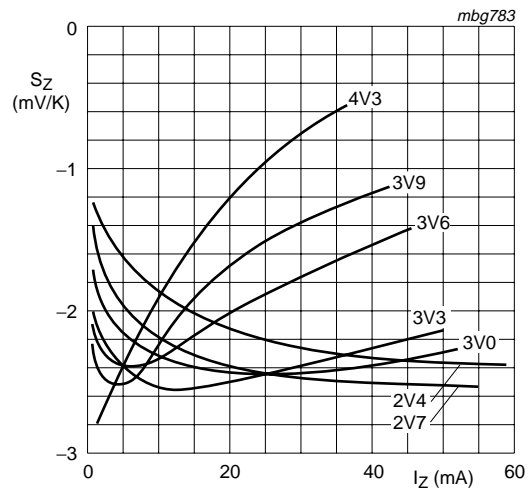
Table 9. Characteristics per type; NZX20A to NZX36X*T_j = 25 °C unless otherwise specified.*

NZXxxx	Sel	Working voltage V _Z (V)		Differential resistance r _{dif} (Ω)	Reverse current I _R (μA)	
		I _Z = 2 mA		I _Z = 2 mA	Max	V _R (V)
		Min	Max	Max		
20	A	18.8	19.7	60	0.05	14
	B	19.5	20.4			
	C	20.2	21.2			
22	A	20.9	21.9	65	0.05	15.4
	B	21.6	22.6			
	C	22.3	23.3			
24	A	22.9	24.0	70	0.05	16.8
	B	23.6	24.7			
	C	24.3	25.5			
	X	22.61	23.77			
27	A	25.2	26.6	80	0.05	18.9
	B	26.2	27.6			
	C	27.2	28.6			
	X	26.99	28.39			
30	A	28.2	29.6	100	0.05	21
	B	29.2	30.6			
	C	30.2	31.6			
	X	29.02	30.51			
33	A	31.2	32.6	120	0.05	23.1
	B	32.2	33.6			
	C	33.2	34.5			
36	A	34.2	35.7	140	0.05	25.2
	B	35.3	36.8			
	C	36.4	38.0			
	X	35.36	37.19			



$T_j = 25\text{ }^\circ\text{C}$

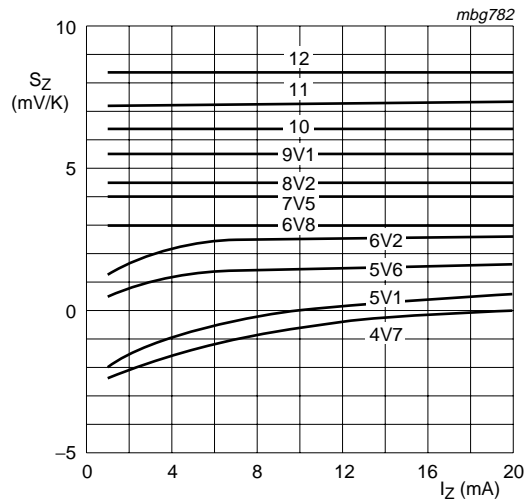
Fig 2. Forward current as a function of forward voltage; typical values



NZX2V4 to NZX4V3

$T_j = 25\text{ }^\circ\text{C}$ to $150\text{ }^\circ\text{C}$

Fig 3. Temperature coefficient as a function of working current; typical values

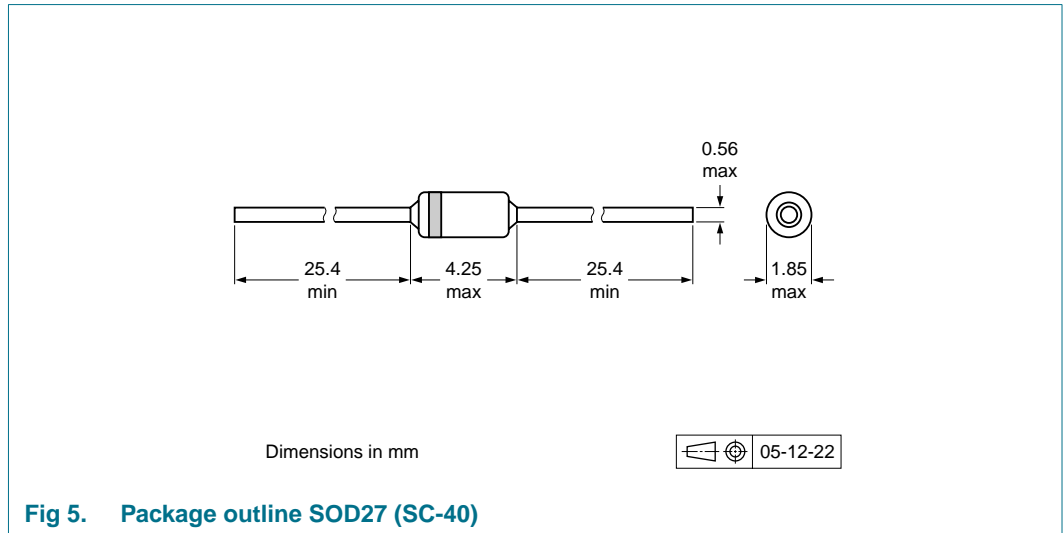


NZX4V7 to NZX12

$T_j = 25\text{ }^\circ\text{C}$ to $150\text{ }^\circ\text{C}$

Fig 4. Temperature coefficient as a function of working current; typical values

8. Package outline



9. Packing information

Table 10. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.^[1]

Type number ^[2]	Package	Description	Packing quantity	
			5000	10000
NZX2V4A to NZX36X	SOD27	26 mm tape ammopack, axial	-143	-
		52 mm tape ammopack, axial	-	-133
		52 mm reel pack, axial	-	-113

[1] For further information and the availability of packing methods, see [Section 12](#).

[2] The series consists of 111 types with nominal working voltages from 2.4 V to 36 V.

10. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NZX_SER_2	20090603	Product data sheet	-	NZX_SER_1
Modifications:	<ul style="list-style-type: none">• 42 type numbers added• Section 1.1 "General description": amended• Figure 1: updated• Table 5: P_{tot} condition amended			
NZX_SER_1	20080724	Product data sheet	-	-

11. Legal information

11.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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